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February 2009

SG6901A CCM PFC/Flyback PWM Combination Controller

Features

- Interleaved PFC/PWM Switching
- Low Startup and Operating Current
- Innovative Switching Charge Multiplier Divider
- Multi-vector Control for Improved PFC Output Transient Response
- Average-Current-Mode Control for PFC
- Programmable Two-Level PFC Output Voltage Protections
- PFC and PWM Feedback Open-Loop Protection
- Cycle-by-Cycle Current Limiting for PFC/PWM
- Slope Compensation for PWM
- H/L Line Over-Power Compensation for PWM
- Brownout Protection
- Over-Temperature Protection (OTP)

Applications

- Switching Power Supplies with Active PFC and Standby Power
- High-Power Adaptors

Description

The highly integrated SG6901A is designed for power supplies with boost PFC and flyback PWM. It requires very few external components to achieve versatile protections. It is available in a 20-pin SOP package.

A proprietary interleave-switching feature synchronizes the PFC and PWM stages and reduces switching noise.

For PFC stage, the proprietary multi-vector control scheme provides a fast transient response in a low-bandwidth PFC loop, in which the overshoot and undershoot of the PFC voltage are clamped. If the feedback loop is broken, the SG6901A shuts off PFC to prevent extra-high voltage on output.

For the flyback PWM, the synchronized slope compensation ensures the stability of the current loop under continuous-conduction-mode operation. Built-in line-voltage compensation maintains constant output-power limit. Hiccup operation during output overloading is also guaranteed.

In addition, SG6901A provides protection functions, such as brownout and RI pin open/short protection.

Ordering Information

Part Number	Operating Temperature Range	© Eco Status Package		Packing Method
SG6901ASZ	-30°C to +85°C	RoHS	20-Lead, Small Outline Integrated Circuit (SOIC), JEDEC MS013, .300 inch, Wide Body	Tape & Reel

For Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Application Circuit

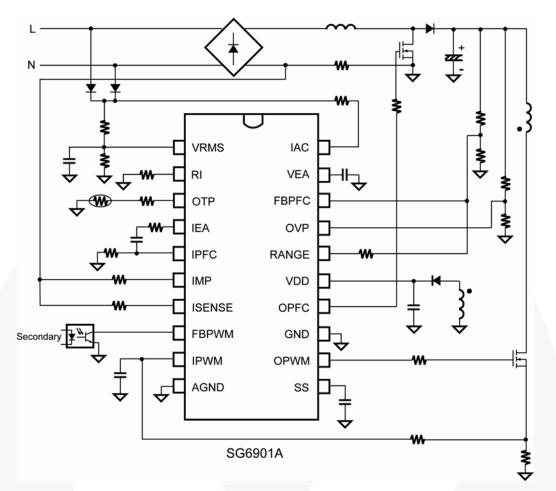


Figure 1. Typical Application

Block Diagram Internal Bias 16 RANGE VDD 15 UVLO OVP IAC 20 LOCK 100 JIA AC input 3 OTP Delay **VRMS** UVP 100µА Open loop VEA 19 14 OPFC FBPFC 18 UVP Multi-Vector Clamper OVP OVP 17 **ISENSE** IMP 12 OPWM S Q 5 **IPFC** R **IEA** IPWM Slope Compensation 2 osc RI Switching 8 FBPWM 50 JLA Open/Shor ► LOCK SS 13 GND

Figure 2. Block Diagram

AGND 10

Marking Information



T- S=SOP
P- Z=Lead Free
Null=regular package
XXXXXXXX- Wafer Lot
Y: Year; WW: Week
V: Assembly Location

Figure 3. Top Mark

Pin Configuration

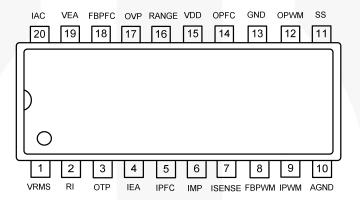


Figure 4. Pin Configuration

Pin Definitions

Pin#	Name	Description				
1	VRMS	Line voltage detection. The pin is used for PFC multiplier, RANGE control of PFC output voltage, and brownout protection. For brownout protection, the controller is disabled after a delay time when the VRMS voltage drops below a threshold.				
2	RI	Reference setting. One resistor connected between RI and ground determines the switching frequency. The switching frequency is equal to [1560 / RI] KHz, where R _I is in K Ω . For example, if R _I is equal to 24K Ω , the switching frequency is 65KHz.				
3	ОТР	Over-temperature protection. A constant current is output from this pin. An external NTC thermistor must be connected from this pin to ground. The impedance of the NTC thermistor decreases whenever the temperature increases. Once the voltage of the OTP pin drops be the OTP threshold, the SG6901A is disabled.				
4	IEA	PFC current amplifier output. The signal from this pin is compared with an internal sawtooth to determine the pulse width for PFC gate drive.				
5	IPFC	The inverting input of the PFC current amplifier. Proper external compensation circuits result in excellent input power factor via average-current-mode control.				
6	IMP	The non-inverting input of the PFC current amplifier and the output of multiplier. Proper external compensation circuits results in excellent input power factor via average-current-mode control.				
7	ISENSE	Current limit. A resistor from this pin to GND sets the current limit.				
8	FBPWM	The control input for voltage-loop feedback of PWM stage. It is internally pulled high through a $6.5 k\Omega$ resistance. Usually an external opto-coupler from secondary feedback circuit is connected to this pin.				
9	IPWM	The current-sense input for the flyback PWM. Via a current sense resistor, this pin provides the control input for peak-current-mode control and cycle-by-cycle current limiting.				
10	AGND	Signal ground.				
11	SS	Soft start. During startup, the SS pin charges an external capacitor with a $50\mu A$ (R _i = $24K\Omega$) constant current source. The voltage on FBPWM is clamped by SS during startup. In the event of a protection condition occurring and/or PWM being disabled, the SS pin is quickly discharged.				
12	OPWM	The totem-pole output drive for the flyback PWM MOSFET. This pin is internally clamped under 17V to protect the MOSFET.				
13	GND	Power ground.				
14	OPFC	The totem-pole output drive for the PFC MOSFET. This pin is internally clamped under 17V to protect the MOSFET.				
15	VDD	The power supply pin.				
16	RANGE	The RANGE pin has high impedance whenever the V_{RMS} voltage is lower than a threshold. The PFC output voltage at low line can be reduced to improve efficiency.				
17	The PFC output voltage at low line can be reduced to improve efficiency. The PFC stage over-voltage input. The comparator disables the PFC output driver if the voltage at this input exceeds a threshold. This pin can be connected to FBPFC or it can be connected to the PFC boost output through a divider network.					
18	FBPFC	The feedback input for PFC voltage loop. The inverting input of PFC error amplifier. This pin is connected to the PFC output through a divider network.				
19	VEA	The error amplifier output for PFC voltage feedback loop. A compensation network (usually a capacitor) is connected between this pin and ground. A large capacitor value results in a narrow bandwidth and improves the power factor.				
20	IAC	This input is used to provide current reference for the multiplier.				

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	Parameter			Unit
V_{DD}	DC Supply Voltage			25	V
I _{AC}	Input AC Current			2	mA
V _{HIGH}	OPWM, OPFC, IAC		-0.3	25.0	V
V_{LOW}	Others		-0.3	7.0	V
P _D	Power Dissipation at T _A < 50°C			1.15	W
TJ	Operating Junction Temperature		-40	+125	°C
T _{STG}	Storage Temperature Range		-55	+150	°C
θ _{JC}	Thermal Resistance (Junction-to-Ca	ase)		+23.64	°C/W
TL	Lead Temperature (Soldering)			+260	°C
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114		4.5	KV
LSD	Lieurostatio Discriarge Capability	Machine Model, JESD22-A115		250	V

Notes:

- 1. All voltage values, except differential voltage, are given with respect to GND pin.
- 2. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
T _A	Operating Ambient Temperature		+85	°C

 V_{DD} =15V and T_{A} =25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
VDD SECTION	NC					•
$V_{\text{DD-OP}}$	Continuously Operating Voltage				20	V
I _{DD-ST}	Startup Current	$0V < V_{DD} < V_{DD-ON}$		10	25	μΑ
I _{DD-OP}	Operating Current	V _{DD} =15V; OPFC, OPWM Open; R _I =24KΩ		6	10	mA
$V_{\text{DD-ON}}$	Start Threshold Voltage		11	12	13	V
V_{DD-OFF}	Minimum Operating Voltage		9	10	11	V
$V_{\text{DD-OVP}}$	V _{DD} OVP Threshold		23.5	24.5	25.5	V
t _{D-VDDOVP}	Debounce Time of V _{DD} OVP		8		25	μs
OSCILLATO	PR SECTION					
f _{OSC}	PWM Frequency	R _I =24KΩ	62	65	68	KHz
Rı	RI Pin Resistance Range		15.6		47.0	ΚΩ
R _{I-OPEN}	RI Pin Open Protection	If R _I >R _{I-OPEN} , SG6901A Turns Off		200		ΚΩ
R _{I-SHORT}	RI Pin Short Protection	If R _I <r<sub>I-SHORT, SG6901A Turns Off</r<sub>		2		ΚΩ
VRMS SECT	FION (for UVP and RANGE)					
V _{RMS-UVP-1}	RMS AC Voltage Under-Voltage Protection Threshold (with t _{UVP} delay)		0.75	0.80	0.85	V
V _{RMS-UVP-2}	Recovery Level on V _{RMS}		V _{RMS-UVP-} 1 + 0.16V	V _{RMS-} _{UVP-1} + 0.18V	V _{RMS-} _{UVP-1} + 0.2V	V
t _{D-PWM}	When UVP Occurs, Interval from PFC Off to PWM Off		t _{∪∨P-} _{Min} +9		t _{UVP-} _{Min} +14	ms
t _{UVP}	Under-Voltage Protection Delay Time		150	195	240	ms
V_{RMS-H}	High V _{RMS} Threshold for RANGE Comparator		1.90	1.95	2.00	V
V _{RMS-L}	Low V _{RMS} Threshold for RANGE Comparator		1.55	1.60	1.65	V
t _{RANGE}	Range-Enable Delay Time		140	170	200	ms
V _{OL}	Output Low Voltage of RANGE Pin	I _o =1mA		1	0.5	V
I _{OH}	Output High Leakage Current of RANGE Pin	RANGE=5V			50	nA

Continued on the following page...

 V_{DD} =15V and T_{A} =25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
PFC STAGE					•	•
Voltage Erro	or Amplifier					
V_{REF}	Reference Voltage		2.95	3.00	3.05	V
Av	Open-Loop Gain			60		dB
Zo	Output Impedance			110		ΚΩ
OVP _{PFC}	PFC Over-Voltage Protection (OVP Pin)		3.20	3.25	3.30	V
$\triangle OVP_{PFC}$	PFC Feedback Voltage Protection Hysteresis		60	90	120	mV
t _{OVP-PFC}	Debounce Time of PFC OVP		40	70	120	μs
V _{FBPFC-H}	Clamp-High Feedback Voltage		3.10	3.15	3.20	V
G _{FBPFC-H}	Clamp-High Gain		/:	0.5		μΑ/mV
V _{FBPFC-L}	Clamp-Low Feedback Voltage		2.75	2.85	2.90	V
G _{FBPFC-L}	Clamp-Low Gain			6.5		mA/mV
I _{FBPFC-L}	Maximum Source Current		1.5	2.0		mA
I _{FBPFC-H}	Maximum Sink Current		70	110		μA
UVP _{FBPFC}	PFC Feedback Under-Voltage Protection		0.35	0.40	0.45	V
t _{UVP-FBPFC}	Debounce Time of PFC UVP		40	70	120	μs
CURRENT E	RROR AMPLIFIER					
V _{OFFSET}	Input Offset Voltage ((-) > (+))			8		mV
Aı	Open-Loop Gain			60		dB
BW	Unit Gain Bandwidth			1.5		MHz
CMRR	Common Mode Rejection Ratio	V _{CM} =0 to +1.5V		70		dB
V _{OUT-HIGH}	Output High Voltage		3.2			V
$V_{\text{OUT-LOW}}$	Output Low Voltage				0.2	V
I _{MR1} , I _{MR2}	Reference Current Source	R_{I} =24K Ω (I_{MR} =20+ I_{RI} •0.8)	50		70	μA
Iμ	Maximum Source Current		3			mA
I _H	Maximum Sink Current			0.25		mA

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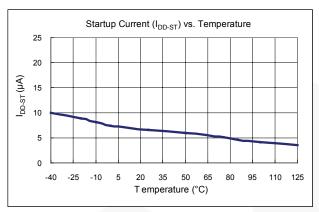
 V_{DD} =15V and T_{A} =25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
PEAK CURF	RENT LIMIT					
l _P	Constant Current Output	R _I =24KΩ	90	100	110	μA
	Peak Current Limit Threshold	V _{RMS} =1.05V	0.15	0.20	0.25	V
V_{PK}	Voltage Cycle-by-Cycle Limit (V _{SENSE} < V _{PK})	V _{RMS} =3V	0.35	0.40	0.45	V
t _{PD-PFC}	Propagation Delay				200	ns
t _{LEB-PFC}	Leading-Edge Blanking Time		270	350	450	ns
MULTIPLIEF	1		1		l.	
I _{AC}	Input AC Current	Multiplier Linear Range	0		360	μA
I _{MO-max}	Maximum Multiplier Current Output	R _I =24KΩ	1	250		μA
I _{MO-1}	Multiplier Current Output (Low-line, High-Power)	V_{RMS} =1.05V; I_{AC} =90 μ A; V_{EA} =7.5V; R_{I} =24K Ω	200	250	280	μA
I _{MO-2}	Multiplier Current Output (High-line, High-Power)	V _{RMS} =3V; I _{AC} =264μA; V _{EA} =7.5V; R _I =24KΩ	65	85		μA
V_{IMP}	Voltage of IMP Open		3.4	3.9	4.4	V
PFC OUTPU	T DRIVER					
V_Z	Output Voltage Maximum (Clamp)	V _{DD} =20V		16	18	V
V _{OL-PFC}	Output Voltage Low	V _{DD} =15V; I _O =100mA			1.5	V
t _{PFC}	Interval OPFC Lags Behind OPWM at Startup		9.0	11.5	14.0	ms
V _{OH-PFC}	Output Voltage High	V _{DD} =13V; I _O =100mA	8			V
t _{R-PFC}	Rising Time	V _{DD} =15V; C _L =5nF; O/P=2V to 9V	40	70	120	ns
t _{F-PFC}	Falling Time	V _{DD} =15V; C _L =5nF; O/P=9V to 2V	40	60	110	ns
DCY _{MAX}	Maximum Duty Cycle		93		98	%
PWM STAGI						
FBPWM						
A _{v-PWM}	FB to Current Comparator Attenuation		2.5	3.1	3.5	V/V
Z _{FB}	Input Impedance		4	5	7	ΚΩ
I _{FB}	Maximum Source Current		0.8	1.2	1.5	mA
FB _{OPEN-LOOP}	PWM Open-Loop Protection Voltage		4.2	4.5	4.8	V
t _{OPEN-PWM}	PWM Open-Loop Protection Delay Time		45	56	70	ms
t _{OPEN-PWM-}	Interval of PWM Open-Loop Protection Reset		450	600	750	ms

Continued on the following page...

 V_{DD} =15V and T_{A} =25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
PWM CURREN	NT SENSE			•	•	•
t _{PD-PWM}	Propagation Delay to Output	V _{DD} =15V, OPWM<=9V	60		120	ns
V _{LIMIT-1}	Peak Current Limit Threshold Voltage1	RANGE=Open	0.65	0.70	0.75	V
V _{LIMIT-2}	Peak Current Limit Threshold Voltage2	RANGE=Ground	0.60	0.65	0.70	V
t _{LEB-PWM}	Leading-Edge Blanking Time		270	350	450	ns
$ riangle V_{SLOPE}$	Slope Compensation		0.45	0.50	0.55	V
PWM OUTOUT	DRIVER					
$V_{Z\text{-PWM}}$	Output Voltage Maximum (Clamp)	V _{DD} =20V		16	18	V
V _{OL-PWM}	Output Voltage Low	V _{DD} =15V; I _O =100mA			1.5	V
V _{OH-PWM}	Output Voltage High	V _{DD} =13V; I _O =100mA	8			V
t _{R-PWM}	Rising Time	V _{DD} =15V; C _L =5nF; O/P=2V to 9V	30	60	120	ns
t _{F-PWM}	Falling Time	V _{DD} =15V; C _L =5nF; O/P=9V to 2V	30	50	110	ns
DCY _{MAXPWM}	Maximum Duty Cycle		73	78	83	%
OTP SECTION						
I _{OTP}	OTP Pin Output Current	R _I =24KΩ	90	100	110	μΑ
V _{OTP-ON}	Recovery Level on OTP		1.35	1.40	1.45	V
V _{OTP-OFF}	OTP Threshold Voltage		1.15	1.20	1.25	V
t _{OTP}	OTP Debounce Time		8	7	25	μs
SOFT START	SECTION					
I _{SS}	Constant Current Output for Soft-Start	R _T =24KΩ	44	50	56	μА
R_D	Discharge R _{DSON}			470		Ω



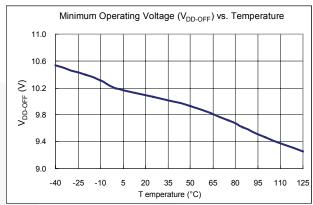


Figure 5. Startup Current

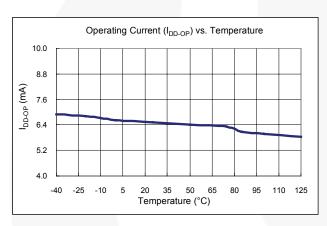


Figure 6. V_{DD} Turn-Off Threshold Voltage

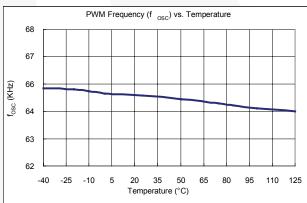


Figure 7. Operating Current

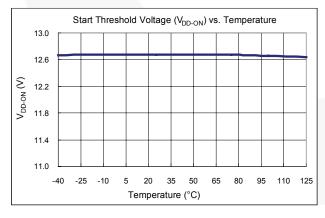


Figure 8. PWM Frequency

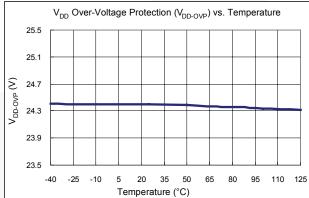
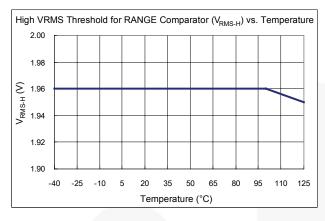


Figure 9. V_{DD} Turn-On Threshold Voltage

Figure 10. V_{DD} OVP Threshold Voltage



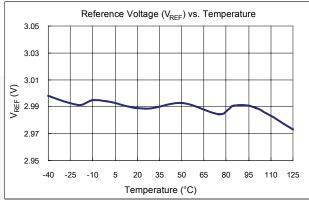
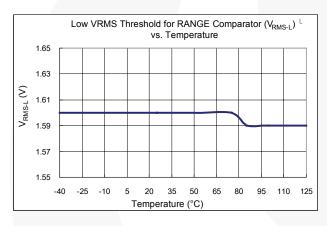


Figure 11. High V_{RMS} Threshold for RANGE Comparator

Figure 12. Reference Voltage



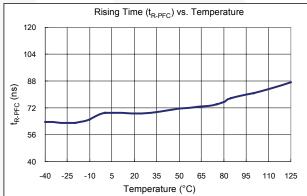
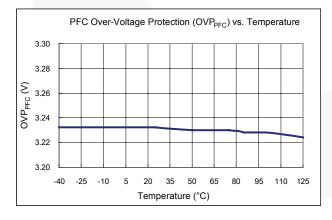


Figure 13. Low V_{RMS} Threshold for RANGE Comparator

Figure 14. OPFC Rising Time



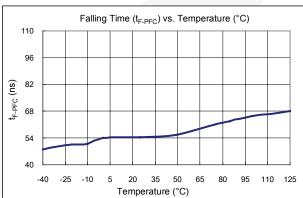
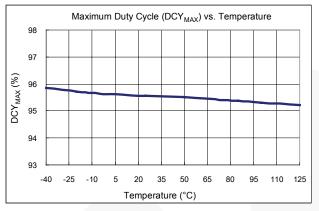


Figure 15. PFC OVP Threshold Voltage

Figure 16. OPFC Falling Time



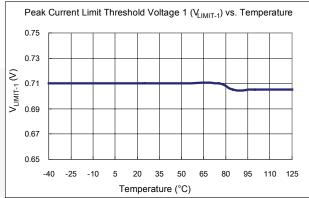
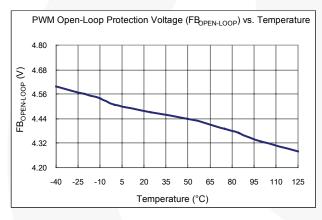


Figure 17. PFC Maximum Duty Cycle





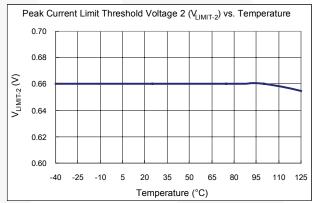
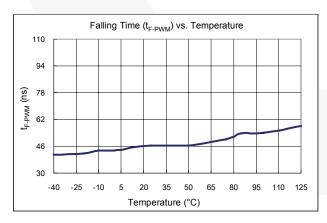


Figure 19. PWM Open-Loop Protection Voltage

Figure 20. Peak Current Limit Threshold Voltage2



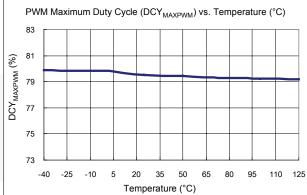


Figure 21. OPWM Falling Time

Figure 22. PWM Maximum Duty Cycle

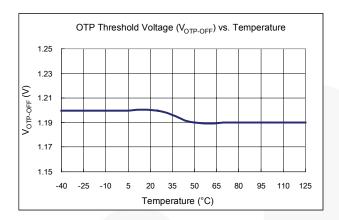


Figure 23.V_{DD} OTPurn Threshold Voltage

Functional Description

SG6901A is a highly integrated PFC/PWM combination controller. Many functions and protections are built in to provide a compact design. The following sections describe the operation and function.

Switching Frequency and Current Sources

The switching frequency can be programmed by the resistor RI connected between RI pin and GND. The relationship is:

$$f_{OSC} = \frac{1560}{R_1 (k\Omega)} (kHz)$$
 (1)

For example, a $24K\Omega$ resistor R_l results in a 65KHz switching frequency. Accordingly, a constant current, I_T , flows through R_l :

$$I_{T} = \frac{1.2V}{R_{L} (k\Omega)} (mA)$$
 (2)

I_T is used to generate internal current reference.

Line Voltage Detection (VRMS)

Figure 24 shows a resistive divider with low-pass filtering for line-voltage detection on the VRMS pin. The VRMS voltage is used for the PFC multiplier, brownout protection, and range control.

For brownout protection, SG6901A is disabled with a 195ms delay if the voltage VRMS drops below 0.8V.

For PFC multiplier and range control, refer to the PFC Operation section below for details.

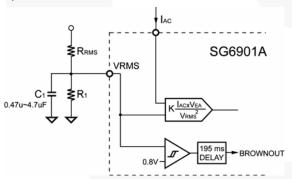


Figure 24.Line Voltage Detection Circuit

Interleave Switching

The SG6901A uses interleaved switching to synchronize the PFC and flyback stages, which reduces switching noise and spreads the EMI emissions. Figure 25 shows off-time, t_{OFF} , inserted between the turn-off of the PFC gate drive and the turn-on of the PWM.

For an universal input (90 \sim 264V_{AC}) power supply applying active boost PFC and flyback as a second stage, the output voltage of PFC is usually designed around 250V at low line and 390V at high line. This can

improve the efficiency at low-line input. The RANGE pin (open-drain structure) is used for the two-level output voltage setting.

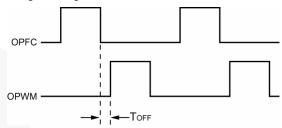


Figure 25.Interleaved Switching Pattern

PFC Operation

The purpose of a boost active power factor corrector (PFC) is to shape the input current of a power supply. The input current waveform and phase follow that of the input voltage. Average-current-mode control is utilized for continuous-current-mode operation for the PFC booster. With the innovative multi-vector control for voltage loop and switching charge multiplier-divider for current reference, excellent input power factor is achieved with good noise immunity and transient response. Figure 26 shows the total control loop for the average-current-mode control circuit.

The current source output from the switching charge multiplier-divider can be expressed as:

$$I_{MO} = K \times \frac{I_{AC} \times V_{EA}}{V_{BMS}^{2}} (\mu A)$$
 (3)

As shown in Figure 26, the current output from the IMP pin is the summation of IMO and IMR1. IMR1 and IMR2 are identical fixed-current sources used to pull high the operating point of the IMP and IPFC pins since the voltage across RS goes negative with respect to ground. Constant current sources IMR1 and IMR2 are typically 60μ A.

Through the differential amplification of the signal across $R_{\rm S}$, better noise immunity is achieved. The output of IEA is compared with an internal sawtooth and the pulse width for PFC is determined. Through the average current-mode control loop, the input current $I_{\rm S}$ is proportional to IMO:

$$I_{MO} \times R_2 = I_S \times R_S \tag{4}$$

According to Equation 4, the minimum value of R_2 and maximum of R_S can be determined since IMO should not exceed the specified maximum value.

There are different concerns in determining the value of the sense resistor $R_{\rm S}$. The value of $R_{\rm S}$ should be small enough to reduce power consumption, but large enough to maintain the resolution. A current transformer (CT) may be used to improve efficiency of high-power converters.

To achieve good power factor, the voltage for V_{RMS} and V_{EA} should be kept as constant as possible, according to Equation 5. Good RC filtering for V_{RMS} and narrow bandwidth (lower than the line frequency) for voltage loop are suggested for better input current shaping. The transconductance error amplifier has output impedance ZO and a capacitor C_{EA} ($1\mu F \sim 10\mu F$) should be connected to ground. This establishes a dominant pole f1 for the voltage loop:

$$f_1 = \frac{1}{2\pi \times Z_O \times C_{FA}}$$
 (5)

The average total input power can be expressed as:

$$Pin = V_{IN(rms)} \times I_{IN(rms)}$$

$$\propto V_{RMS} \times I_{MO}$$

$$\propto V_{RMS} \times \frac{I_{AC} \times V_{EA}}{V_{RMS}^{2}}$$

$$\frac{Vin}{R_{AC} \times V_{EA}} \times V_{EA}$$

$$\propto V_{RMS} \times \frac{\frac{Vin}{R_{AC}} \times V_{EA}}{V_{RMS}^{2}}$$

$$= \sqrt{2} \times \frac{V_{EA}}{R_{AC}}$$
(6)

From Equation 6, V_{EA} , the output of the voltage error amplifier, controls the total input power and the power delivered to the load.

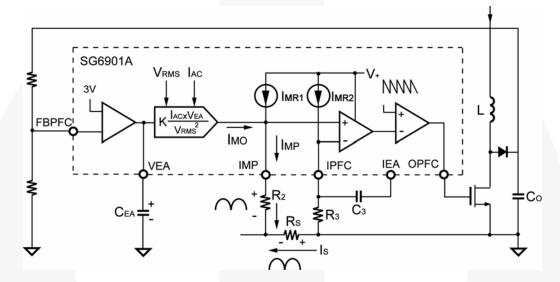
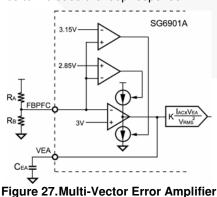


Figure 26. Average-Current-Mode Control Loop

Multi-Vector Error Amplifier

Although the PFC stage has a low bandwidth voltage loop for better input power factor, the innovative multivector error amplifier provides a fast transient response to clamp the overshoot and undershoot of the PFC output voltage.

0 shows the block diagram of the multi-vector error amplifier. When the variation of the feedback voltage exceeds $\pm 5\%$ of the reference voltage, the transconductance error amplifier adjusts its output impedance to increase the loop response.



PFC Over-Voltage Protection

Using a voltage divider from the output of PFC to the OVP pin, the PFC output voltage can be safely protected. Once the voltage on the OVP pin is over OVPFC, the OPFC is disabled. THE OPFC is not enabled again until the OVP voltage falls below OVPPFC.

Cycle-by-Cycle Current Limiting

SG6901A provides cycle-by-cycle current limiting for both PFC and PWM stages. Figure 28 shows the peak current limit for the PFC stage. The PFC gate drive is terminated once the voltage on the ISENSE pin goes below V_{PK} .

The voltage of V_{RMS} determines the voltage of V_{PK} . The relationship between V_{PK} and V_{RMS} is shown in Figure 28.

The amplitude of the constant current, I_p , is determined by the internal current reference according to:

$$I_{P} = 2 \times \frac{1.2V}{R_{I}} \tag{8}$$

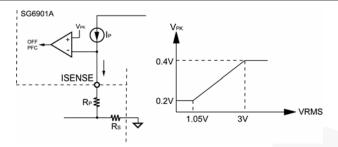


Figure 28. V_{RMS} Controlled Current Limiting

The peak current of the ISENSE is given by $(V_{RMS} < 1.05V)$:

$$I_{SENSE_peak} = \frac{(I_p \times R_p) - 0.2V}{R_s}$$
 (8)

Flyback PWM and Slope Compensation

As shown in Figure 29, peak-current-mode control is utilized for flyback PWM. The SG6901A inserts a synchronized 0.5V ramp at the beginning of each switching cycle. This built-in slope compensation ensures stable operation for continuous current-mode operation.

When the IPWM voltage, across the sense resistor, reaches the threshold voltage (0.9V), the OPWM is turned off after a small propagation delay $t_{\text{PD-PWM}}$.

To improve stability or prevent sub-harmonic oscillation, a synchronized positive-going ramp is inserted at every switching cycle.

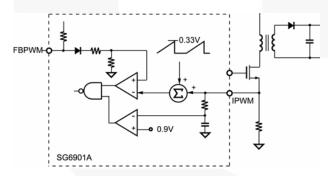


Figure 29. Peak Current Control Loop

Limited Power Control

Every time the output of the power supply is shorted or overloaded, the FBPWM voltage increases. If the FBPWM voltage is higher than a designed threshold, FBOPEN-LOOP (4.5V) for longer than $t_{\text{OPEN-PWM}}$ (56ms), the OPWM is turned off.

As long as the voltage on the VDD pin is larger than $V_{\text{DD-OFF}}$ (minimum operating voltage), the OPWM is not enabled. This protection is reset every $t_{\text{OPEN-PWM-Hiccup}}$ interval. A low-frequency hiccup mode protection prevents the power supply from being overheated under overload conditions.

Over-Temperature Protection

The OTP pin provides for over-temperature protection. A constant current is output from this pin. If $R_{\rm l}$ is equal to $24 {\rm K}\Omega,$ the magnitude of the constant current is $100 \mu A.$ An external NTC thermistor must be connected from this pin to ground, as shown as Figure 30. When the OTP voltage drops below $V_{\rm OTP-OFF}$ (1.2V), SG6901A is disabled and does not recover until OTP voltage exceeds $V_{\rm OTP-ON}$ (1.4V).

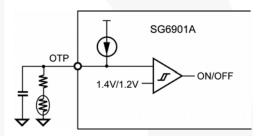


Figure 30.OTP Function

Soft Start

During startup of PWM stage, the SS pin charges an external capacitor with a constant current source. The voltage on FBPWM is clamped by the SS voltage during startup. In the event of a protected condition and/or PWM is disabled, the SS pin guickly discharges.

Gate Driver

SG6901A output stage is a fast totem-pole gate driver. The output driver is clamped by an internal 18V Zener diode to protect the external power MOSFET.

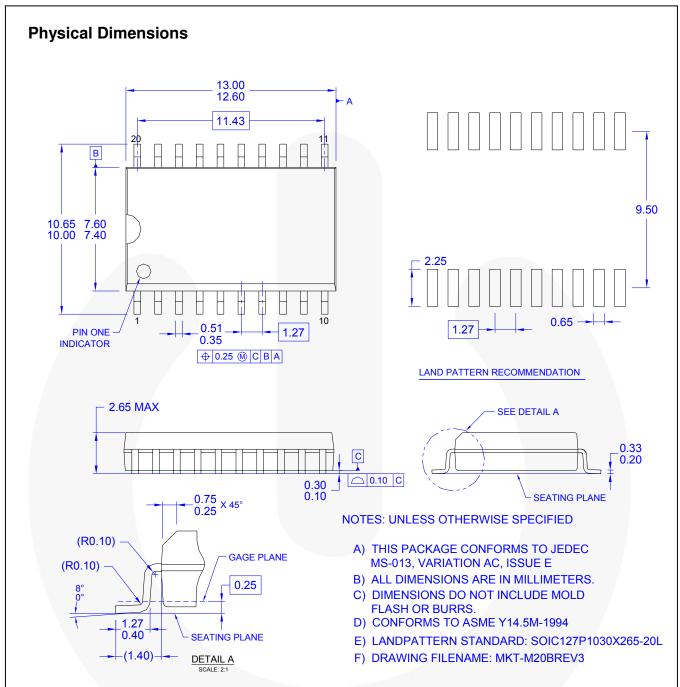


Figure 31. 20-Pin Small Outline Integrated Circuit (SOIC)

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